## **1st Workshop of Spanish Chip Chairs**

11:00 E. Vil	illar and Institutional Representative (TBC)	Session 1: Opening
11:30 <b>Chai</b> i	ir: J.C. López	
11:30 <b>M. L</b> o	Lopez	
The U	UPM-Indra Chair on Microelectronics: Bridging Devices,	
Circu	uits, and Architectures to build the Future of Integrated	
Syste	rems	
11:35 <b>A. R</b> ւ	tubio	
Chip	Chair UPC: Chips for Advanced Architectures and Photonic	
Syste	rems	
11:40 <b>F. J.</b> I	Ballester	Session 2: Multi-Domain Approaches
UPV-	/-VaSiC Chair in Microelectronic Design	
11:45 <b>E. M</b> .	1. Segura	
	gress from the Cátedra Malaga Microelectronics	
11:50 <b>A. J.</b>		
	CHIP: Chair of Microelectronics at the University of Seville	
11:55 Wra <sub>l</sub>	np-up: Pros & Cons of Multi-Domain Chairs	
12:25	Coffee Break	
	ir: F.J. Ballester	
12:55 <b>J. C.</b> .		
	uTxipi and its hidden relation with Chips and Chairs	
13:00 <b>A. As</b>		
	4SENSING: boosting Microelectronics in the Industrial Eco-	
•	em of the Basque Country	
13:05 <b>P. Ló</b>	•	
	T-Televés Chair in Microelectronics	Session 3: System Design
13:10 <b>E. Vi</b> l		
	tabria Chip Chair: Heterogeneous System Design	
13:15 <b>J. C.</b>		
	M PERTE Chip Chair	
13.20	пр-up: Addressing System Design	
13:20	ap-up: Addressing System Design	

14:50 Chair: P. López	
14:50 <b>C. Reig</b>	
Universitat de València: Advanced Materials for the	
Semiconductor and Integrated Circuit Industry	
14:55 <b>F. Gámiz</b>	
Atomically thin, exceptionally powerful: 2D materials in More-	
than-Moore Electronics	
15:00 C. de Dios & M. Portela	
Cátedras ePIQ UC3M – ARQUIMEA Research Center, to foster	
the application of integrated photonics and electronics to the	Session 4: Microelectronic & Photonic
new quantum technologies	Technologies
15:05 <b>P. Muñoz</b>	realmologies
Cátedra PIC-UPV	
15:10 R. Berenguer	
SISPI: Microelectronic Design of Wireless, Battery-less Sensors	
15:15 G. Carpintero	
ePIQ-Pack: Advanced Technologies for Testing, Assembly, and	
Packaging of Electronic and Photonic Integrated Circuits	
15:20 Wrap-up: Technology Training & Research	
15:50 C.G. Triviño	Session 5: Chip Chairs Cooperation in
Joint Report of Activities of the PERTE Chip Chairs	Microelectronics Research and Training
16:10 Coffee Break	
16:10 Coffee Break 16:40 Chair: M. Lopez	
16:40 Chair: M. Lopez 16:40 W. Nobel	
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Networking Dinner